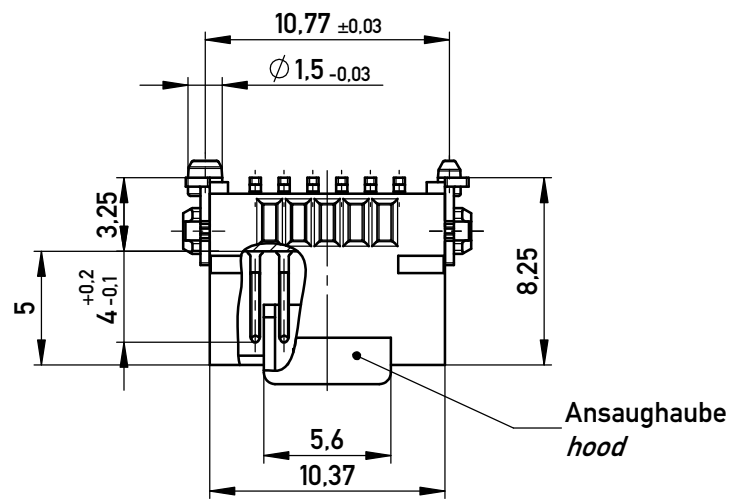
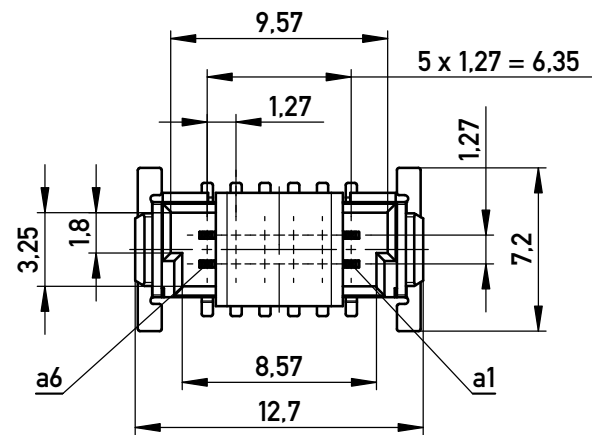
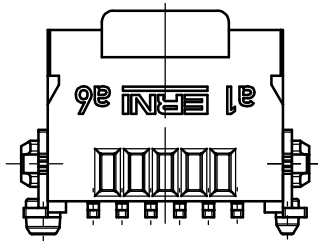
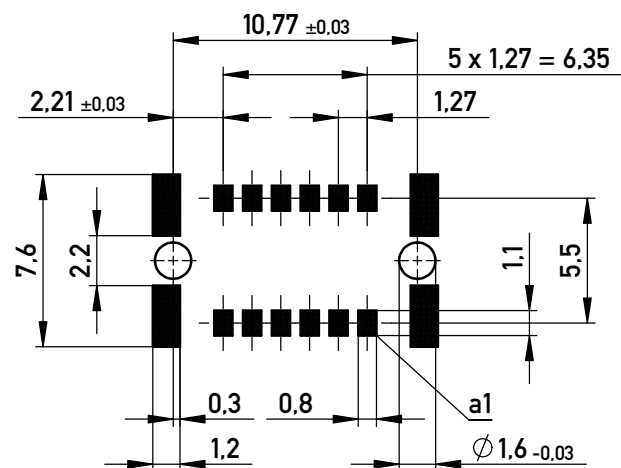


Leiterplatten-Layout Vorschlag für SMT PCB-Layout Proposal for SMT



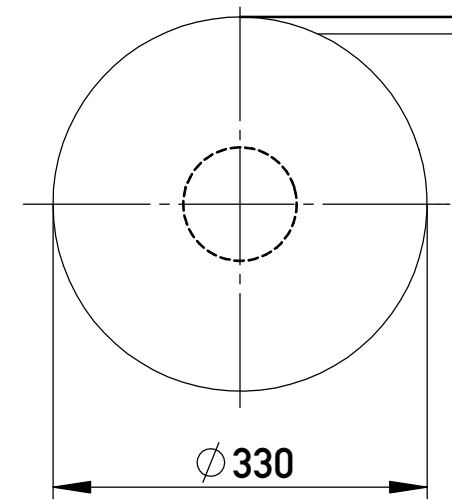
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

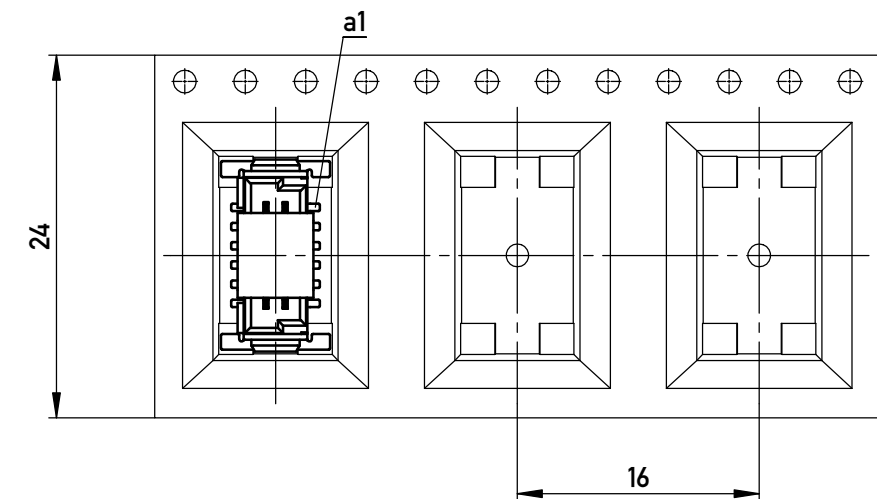
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction

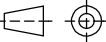


BA 8-03 - Standard Bauhöhe

type 8-03 - Standard Assembly Height

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Proprietary notice pursuant to ISO 10010 to be observed.

Information:				Tolerances		 All Dimensions in mm		Scale 3:1	
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						Messerl. SMC-Q-12-SMD-BA8-03 <i>Male SMC-Q 12-SMD-type8-03</i>			
						www.ERNI.com		100603210067	
e		24.05.2016						A3	
Index		Date				Class		SMCQ	